## Designer's™ Data Sheet

# **SWITCHMODE Series NPN Silicon Power Transistors**

These transistors are designed for high–voltage, high–speed switching of inductive circuits where fall time and RBSOA are critical. They are particularly well–suited for line–operated switchmode applications.

The MJE16004 is a high-gain version of the MJE16002 and MJH16002 for applications where drive current is limited.

Typical Applications:

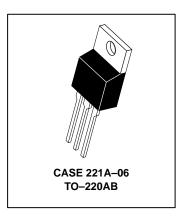
- · Switching Regulators
- · High Resolution Deflection Circuits
- Inverters
- Motor Drives
- Fast Switching Speeds
   50 ns Inductive Fall Time @ 75°C (Typ)
   70 ns Crossover Time @ 75°C (Typ)
- 100°C Performance Specified for:

Reverse–Biased SOA Inductive Switching Times Saturation Voltages Leakage Currents

## MJE16002\* MJE16004\*

\*Motorola Preferred Device

5.0 AMPERE
NPN SILICON
POWER TRANSISTORS
450 VOLTS
80 WATTS



#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCEO(sus)	450	Vdc
Collector–Emitter Voltage	VCEV	850	Vdc
Emitter-Base Voltage	VEB	6.0	Vdc
Collector Current — Continuous — Peak (1)	I <sub>C</sub>	5.0 10	Adc
Base Current — Continuous — Peak (1)	I <sub>B</sub>	4.0 8.0	Adc
Total Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$ Derate above $T_C = 25^{\circ}C$	PD	80 32 0.64	Watts W/°C
Operating and Storage Junction Temperature Range	TJ, Tstg	-65 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.56	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	TL	275	°C

<sup>(1)</sup> Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

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#### REV 2



#### MJE16002 MJE16004

### **ELECTRICAL CHARACTERISTICS** (T $_{C}$ = 25 $^{\circ}$ C unless otherwise noted)

	Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTE	RISTICS (1)		•		•		
Collector–Emitte	er Sustaining Voltage (Table 2) , I <sub>B</sub> = 0)		VCEO(sus)	450	_	_	Vdc
Collector Cutoff (VCEV = 850 (VCEV = 850	Current Vdc, V <sub>BE</sub> (off) = 1.5 Vdc) Vdc, V <sub>BE</sub> (off) = 1.5 Vdc, T <sub>C</sub> = 1	00°C)	ICEV		_	0.25 1.5	mAdc
Collector Cutoff		<u> </u>	ICER	_	-	2.5	mAdc
Emitter Cutoff C (VEB = 6.0 Vo			I <sub>EBO</sub>	_	_	1.0	mAdc
SECOND BREAK	(DOWN				•		
Second Breakdo	own Collector Current with Base	Forward Biased	I <sub>S/b</sub>		See Figure	e 17 or 18	
Clamped Induct	ive SOA with Base Reverse Bias	sed	RBSOA		See Fig	jure 19	
ON CHARACTER	RISTICS (1)		•				
(I <sub>C</sub> = 1.5 Adc (I <sub>C</sub> = 3.0 Adc (I <sub>C</sub> = 3.0 Adc (I <sub>C</sub> = 3.0 Adc	er Saturation Voltage , IB = 0.2 Adc) , IB = 0.15 Adc) , IB = 0.4 Adc) , IB = 0.3 Adc) , IB = 0.4 Adc, T <sub>C</sub> = 100°C) , IB = 0.3 Adc, T <sub>C</sub> = 100°C)	MJE16002 MJE16004 MJE16002 MJE16004 MJE16002 MJE16004	VCE(sat)			1.0 1.0 2.5 2.5 2.5 2.5	Vdc
(IC = 3.0  Adc)	aturation Voltage , I <sub>B</sub> = 0.4 Adc) , I <sub>B</sub> = 0.3 Adc) , I <sub>S</sub> = 0.4 Adc, T <sub>C</sub> = 100°C) , I <sub>B</sub> = 0.3 Adc, T <sub>C</sub> = 100°C)	MJE16002 MJE16004 MJE16002 MJE16004	VBE(sat)		_ _ _ _	1.5 1.5 1.5 1.5	Vdc
DC Current Gai (I <sub>C</sub> = 5.0 Adc	n , V <sub>CE</sub> = 5.0 Vdc)	MJE16002 MJE16004	hFE	5.0 7.0	_ _	_	_
DYNAMIC CHAR	ACTERISTICS						
Output Capacita (V <sub>CB</sub> = 10 Vo	ance dc, I <sub>E</sub> = 0, f <sub>test</sub> = 1.0 kHz)		C <sub>ob</sub>	l	_	200	pF
SWITCHING CHA	ARACTERISTICS						
Resistive Load	(Table 1) MJE16002/MJH	10002			_		
Delay Time			<sup>t</sup> d		30	100	ns
Rise Time	$(I_C = 3.0 \text{ Adc},$	$(I_{B2} = 0.8 \text{ Adc},$	t <sub>r</sub>		100	300	
Storage Time	$V_{CC} = 250 \text{ Vdc},$ $I_{B1} = 0.4 \text{ Adc},$	$R_{B2} = 8.0 \Omega$ )	t <sub>S</sub>	1	1000	3000	_
Fall Time	$PW = 30 \mu s$ ,		tf		60	300	]
Storage Time	Duty Cycle ≤ 2.0%)	$(V_{BE(off)} = 5.0 \text{ Vdc})$	t <sub>S</sub>	_	400	_	
Fall Time		CDE(OII)	t <sub>f</sub>	_	130	_	
Resistive Load	(Table 1) MJE16004/MJH1	6004					
Delay Time			<sup>t</sup> d	_	30	100	ns
Rise Time	$(I_C = 3.0 \text{ Adc},$	$(l_{B2} = 0.6 \text{ Adc},$	t <sub>r</sub>		130	300	]
Storage Time	$V_{CC} = 250 \text{ Vdc},$ $I_{B1} = 0.3 \text{ Adc},$	$R_{B2} = 8.0 \Omega$ )	t <sub>S</sub>		800	2700	]
Fall Time	$PW = 30 \mu s$ ,		t <sub>f</sub>	_	80	350	]
Storage Time	Duty Cycle ≤ 2.0%)	(VBE(off) = 5.0 Vdc)	t <sub>S</sub>		250	_	]
Fall Time		(*BE(UII) = 0.0 *40)	t <sub>f</sub>		60		

<sup>(1)</sup> Pulse Test: PW = 300 μs, Duty Cycle ≤ 2%.

$$*\beta_f = \frac{I_C}{I_{B1}}$$

#### **SWITCHING CHARACTERISTICS** (continued)

Characteristics			Symbol	Min	Тур	Max	Unit
Inductive Load (Table	e 2) MJE16002		•	•	•		
Storage Time			t <sub>SV</sub>	_	500	1600	ns
Fall Time		(T <sub>J</sub> = 100°C)	t <sub>fi</sub>	_	100	200	
Crossover Time	(I <sub>C</sub> = 3.0 Adc, I <sub>B1</sub> = 0.4 Adc,		t <sub>C</sub>	_	120	250	
Storage Time	VBE(off) = 5.0 Vdc, VCE(pk) = 400 Vdc)		t <sub>SV</sub>	_	600	_	
Fall Time	VCE(pk) = 400 vdc)	(T <sub>J</sub> = 150°C)	t <sub>fi</sub>	_	120	_	
Crossover Time			t <sub>C</sub>	_	160	_	
Inductive Load (Table	e 2) MJE16004		•		•		•
Storage Time			t <sub>SV</sub>	_	400	1300	ns
Fall Time		(T <sub>J</sub> = 100°C)	t <sub>fi</sub>	_	80	150	
Crossover Time	(IC = 3.0 Adc, IB1 = 0.3 Adc, VBE(off) = 5.0 Vdc, VCE(pk) = 400 Vdc)		t <sub>C</sub>	_	90	200	
Storage Time			t <sub>SV</sub>	_	450	_	
Fall Time		(T <sub>J</sub> = 150°C)	t <sub>fi</sub>	_	100	_	
Crossover Time			t <sub>C</sub>	_	110	_	1

<sup>(1)</sup> Pulse Test: PW = 300  $\mu s$ , Duty Cycle  $\leq$  2%.

$$*\beta_f = \frac{IC}{IB1}$$

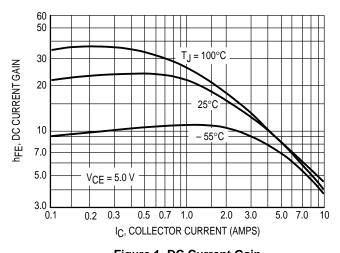


Figure 1. DC Current Gain

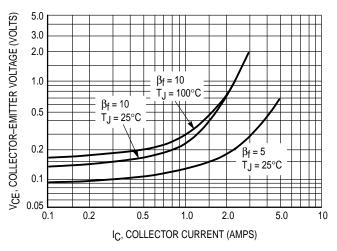


Figure 3. Collector-Emitter Saturation Region

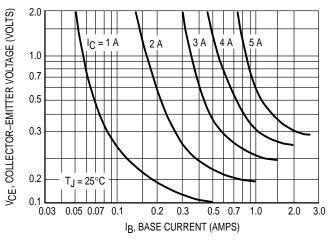


Figure 2. Collector Saturation Region

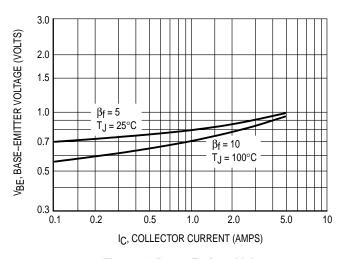


Figure 4. Base-Emitter Voltage

#### **TYPICAL STATIC CHARACTERISTICS (continued)**

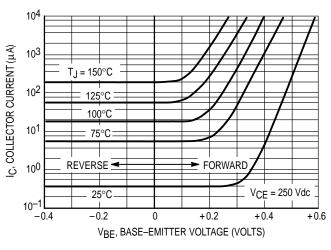


Figure 5. Collector Cutoff Region

Figure 6. Capacitance

#### TYPICAL DYNAMIC CHARACTERISTICS

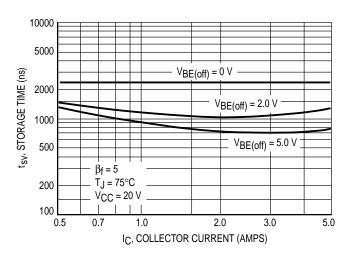


Figure 7. Storage Time

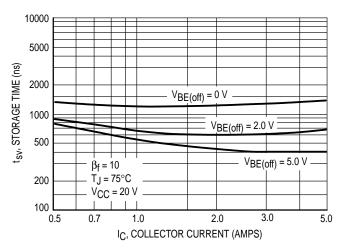


Figure 8. Storage Time

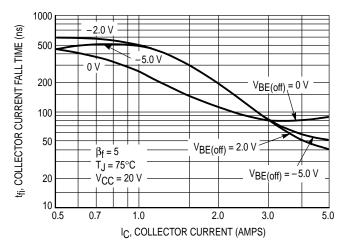


Figure 9. Collector Current Fall Time

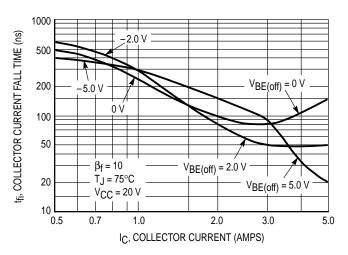
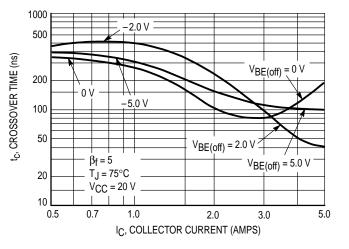


Figure 10. Collector Current Fall Time

#### **TYPICAL DYNAMIC CHARACTERISTICS (continued)**

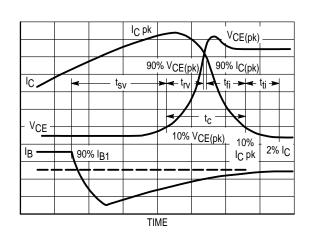


1000 -2.0 V 500 t<sub>c</sub>, CROSSOVER TIME (ns) VBE(off) = 0 V 200 0 V 100 -5.0 V 50  $\beta_f = 10$ VBE(off) = 2.0 V T<sub>J</sub> = 75°C 20 V<sub>CC</sub> = 20 V  $V_{BE(off)} = 5.0 V$ 10 0.7 0.5 1.0 2.0 3.0 5.0 IC, COLLECTOR CURRENT (AMPS)

Figure 11. Crossover Time

Figure 12. Crossover Time

#### TYPICAL ELECTRICAL CHARACTERISTICS



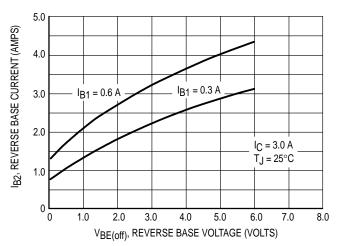


Figure 13. Inductive Switching Measurements

Figure 14. Peak Reverse Base Current

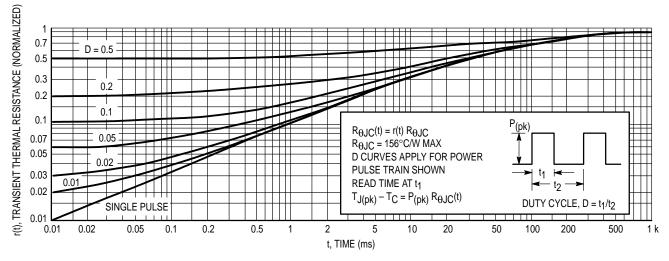


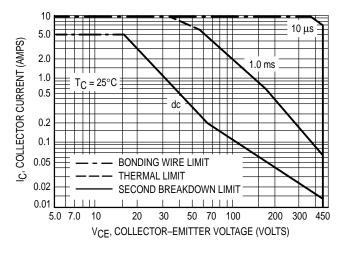
Figure 15. Thermal Response (MJE16002 and MJE16004)

#### SAFE OPERATING AREA INFORMATION

10 9.0

8.0

7.0



IC(pk), COLLECTOR CURRENT (AMPS) 6.0 5.0 4.0 3.0 2.0  $V_{BE(off)} = 0 V$  $V_{BE(off)} = 1.0 \text{ to } 5.0 \text{ V}$ 1.0 100 200 0 500 700 850  $\mathsf{V}_{\mathsf{CE}(\mathsf{pk})}, \mathsf{PEAK}\ \mathsf{COLLECTOR-\!EMITTER}\ \mathsf{VOLTAGE}\ (\mathsf{VOLTS})$ 

Figure 16. Maximum Rated Forward Bias Safe Operating Area (MJE16002 and MJE16004)

Figure 17. Maximum Rated Reverse Bias Safe Operating Area

 $\beta_f \! \geq \! 4$ 

T<sub>J</sub> ≤ 100°C

1000

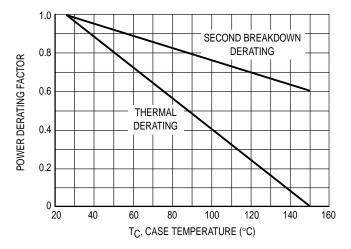


Figure 18. Power Derating

#### SAFE OPERATING AREA INFORMATION

#### **FORWARD BIAS**

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 16 is based on  $T_C = 25^{\circ}C$ ;  $T_{J(pk)}$  is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when  $T_C \ge 25^{\circ}C$ . Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figures 17 and 18 may be found at any case temperature by using the appropriate curve on Figure 20.

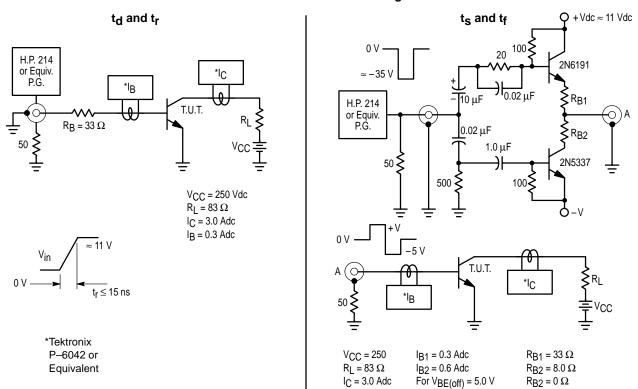
T<sub>J(pk)</sub> may be calculated from the data in Figure 15. At high case temperatures, thermal limitations will reduce the

power that can be handled to values less than the limitations imposed by second breakdown.

#### **REVERSE BIAS**

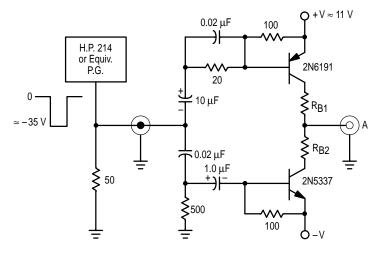
For inductive loads, high voltage and high current must be sustained simultaneously during turn—off, in most cases, with the base—to—emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage—current condition allowable pulling reverse biased turn—off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 17 gives the RBSOA characteristics.

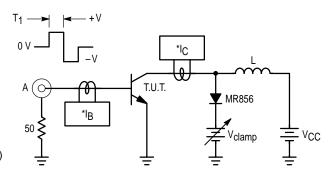
**Table 1. Resistive Load Switching** 



Note: Adjust -V to obtain desired VBE(off) at Point A.

**Table 2. Inductive Load Switching** 



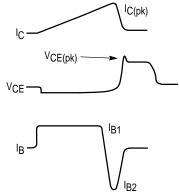


**RBSOA** 

 $R_{B2} = 0$ 

 $L = 200 \mu H$ 

 $V_{CC} = 20 \text{ Volts}$ 



L<sub>coil</sub> (I<sub>Cpk</sub>)

T<sub>1</sub> adjusted to obtain IC(pk)

**Inductive Switching** V<sub>CEO(sus)</sub>

 $L = 200 \, \mu H$ L = 10 mH $R_{B2} = 0$  $R_{B2} = \infty$ 

V<sub>CC</sub> = 20 Volts  $V_{CC} = 20 \text{ Volts}$ 

R<sub>B1</sub> selected for desired I<sub>B1</sub>

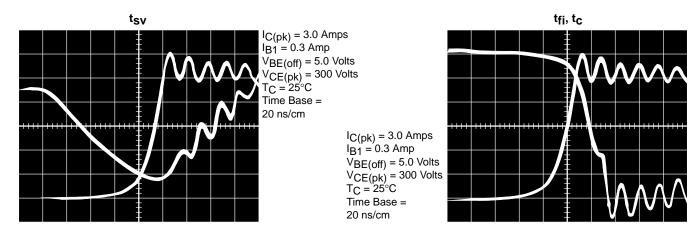
\*Tektronix Scope — Tektronix

P-6042 or 7403 or

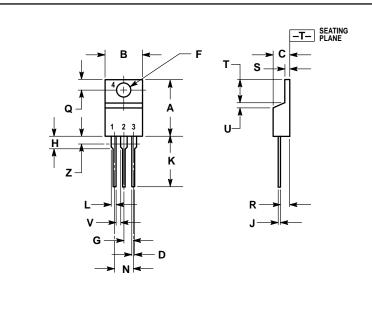
Equivalent Equivalent Note: Adjust –V to obtain desired VBE(off) at Point A.

#### TYPICAL INDUCTIVE SWITCHING WAVEFORMS

R<sub>B1</sub> selected for desired I<sub>B1</sub>



#### **PACKAGE DIMENSIONS**



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.018	0.025	0.46	0.64	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
٧	0.045		1.15		
Z		0.080		2.04	

- STYLE 1:
  PIN 1. BASE
  2. COLLECTOR
  3. EMITTER
  4. COLLECTOR

**CASE 221A-06** TO-220AB **ISSUE Y** 

#### MJE16002 MJE16004

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